

# **DATASHEET**

# IRR60-48C/L661/TR8(ES)

### **Features**

- Compatible with infrared and vapor phase reflow solder process.
- Compatible with automatic placement equipment.
- Bi-color LED wavelength. (660nm, 910nm)
- Compliance Halogen Free(Br < 900ppm, Cl < 900ppm, Br+Cl < 1500ppm)
- Compliance with EU REACH
- This product itself will remain within RoHS compliant version.
- Package size : 6.0mm\*4.8mm\*1.1mm

## **Description**

• IRR60-48C/L661/TR8(ES) is an infrared emitting diode in miniature SMD package, which is molded in a water clear plastic with flat top view lens. The device is spectrally matched with silicon photodiode and phototransistor.

## **Applications**

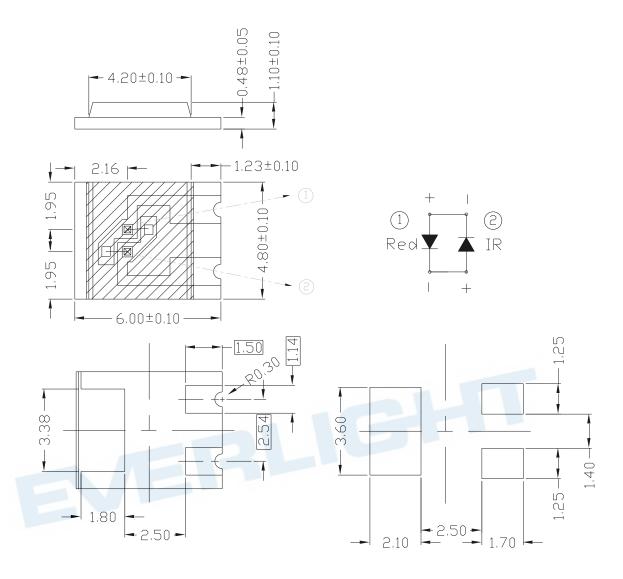
- Sensor
- Oximeter

### **Device Selection Guide**

Device No.	Chip Material	Lens Color
IRR60-48C/L661/TR8(ES)	AlGaInP (660nm) AlGaAs (910nm)	Water clear



# **Package Dimensions**



## • Notes:

- 1. All dimensions are in millimeters
- 2. Tolerances unless dimensions  $\pm 0.1$ mm



# **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Ratin 660nm(Red)	ngs 910nm(IR)	Unit
Continuous Forward Current	$\mathbf{I}_{\mathrm{F}}$	30		mA
Peak Forward Current *1	IFP	150		mA
Reverse Voltage	$V_R$	5		V
Operating Temperature	Topr	-25~	+85	$^{\circ}\mathbb{C}$
Storage Temperature	Tstg	-25 ~	+85	°C
Soldering Temperature *2	Tsol	260	0	°C
Power Dissipation at(or below) 25°C Free Air Temperature	$P_{d}$	70	50	mW
Temperature resistance junction ambient	Rthj-a	550		K/W

**Notes:** \*1:I<sub>FP</sub> Conditions--Pulse Width  $\leq$  10  $\mu$  s and Duty  $\leq$  1%.

**Electro-Optical Characteristics (Ta=25°C)** 

Parameter	Symbol	`	Condition	Min.	Тур.	Max.	Unit
D 11 (T )	$ m I_E$	Red	I <sub>F</sub> =20mA	1.0	2.3		mW /sr
Radiant Intensity	1E	IR	IF–ZUIIIA	1.1	1.5		111 VV /SI
<b>Total Radiated</b>	Po	Red	I <sub>F</sub> =20mA		7.0		mW
Power	FU	IR	IF-ZUIIIA		4.6		111 VV
Peak Wavelength	λр	Red	IF=20mA	657	660	663	nm
	λР	IR		900	910	920	nm
Spectral	Δλ	Red	IF=20mA		20		nm
Bandwidth	Δ /(	IR	11 – 2011/A		30		11111
Forward Voltage	$ m V_{F}$	Red	IF=20mA	1.80	2.10	2.50	V
Torward voltage	V F	IR II I	11 – 2011/A	1.10	1.40	1.60	<b>v</b>
Reverse Current	$I_R$	Red	VR=5V			10	$\mu$ A
		IR				10	
View Angle	2 \theta 1/2	Red	IF=20mA		140		deg
		IR			130		ueg

# HUE: Peak Wavelength

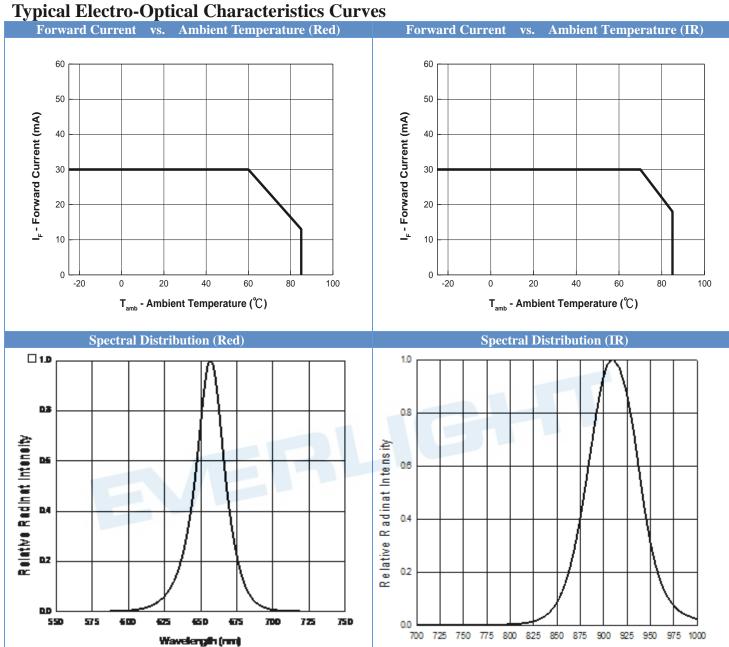
Conditions : Red ,  $I_F = 20 \text{mA}$ 

Tolerance :  $\lambda p \pm 0.5 mm$  Unit: nm

Bin number	Min	Max
A	657	660
В	660	663

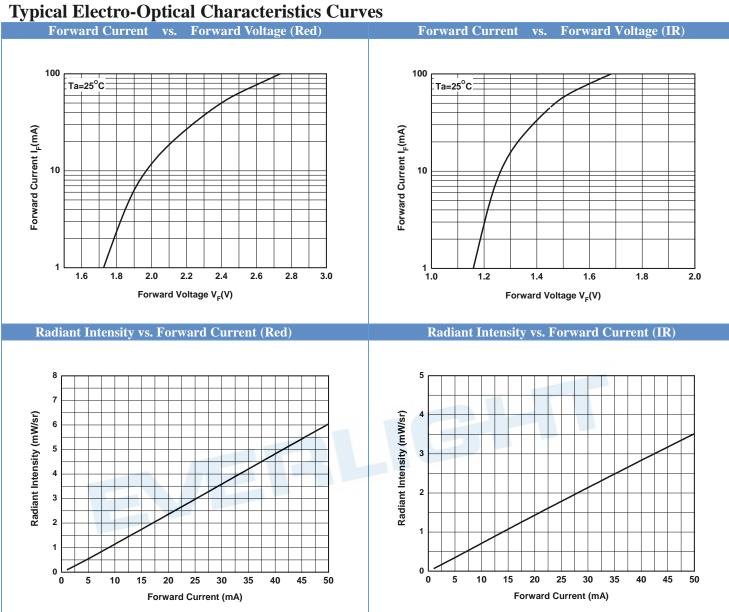
<sup>\*2:</sup>Soldering time  $\leq$  5 seconds.

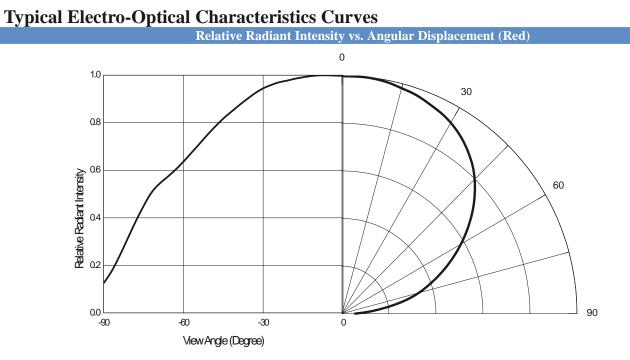




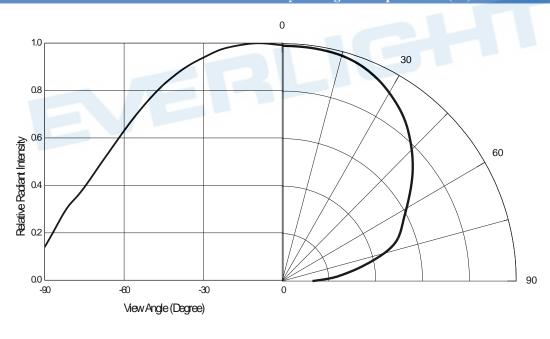
Wavelength (nm)







## Relative Radiant Intensity vs. Angular Displacement (IR)





### **Precautions For Use**

### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

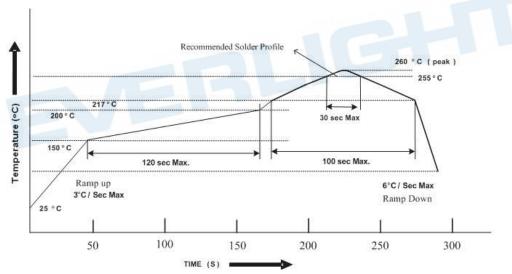
### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5 The LEDs should be used within 24 hours (1 days) after opening the package
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for Min. Min. 24 hours.

### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

### 4. Soldering Iron

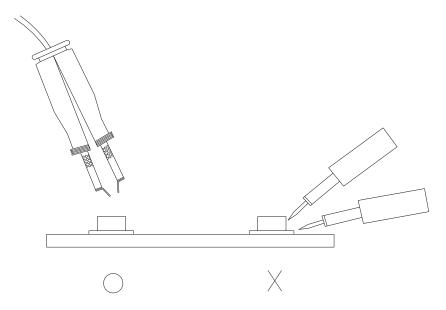
Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5. Repairing

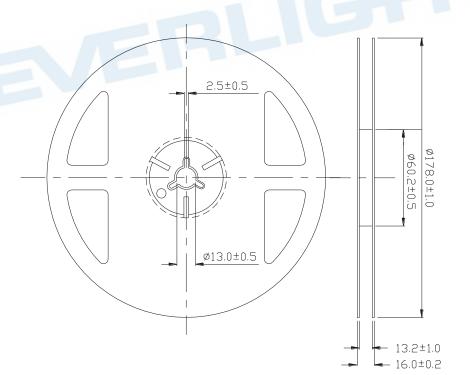
Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a



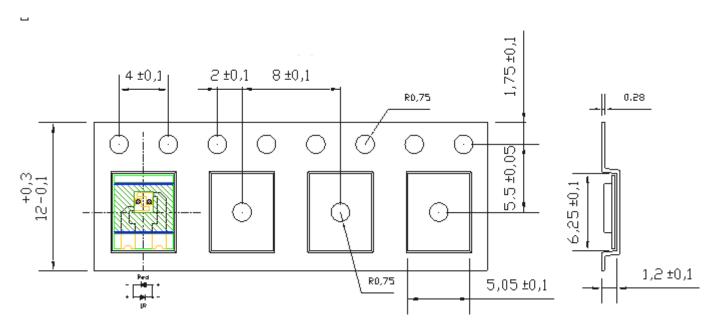
double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



# **Package Dimensions**

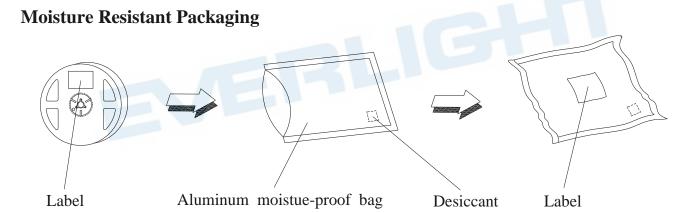


## Carrier Tape Dimensions: Loaded quantity 1000PCS per reel.

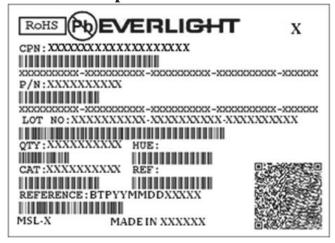


Note: 1. Dimensions are in millimeters

2. The tolerances unless mentioned is  $\pm 0.1$ mm



## **Label Form Specification**



CPN: Customer's Production Number

P/N: Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

**REF:** Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place



## **DISCLAIMER**

- 1. EVERLIGHT AMERICAS reserves the right(s) on the adjustment of product material mix for the specification.
- 2. The product meets EVERLIGHT AMERICAS published specification for a period of twelve (12) months from date of shipment.
- 3. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
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